



# Intel® Core™ i3-3120M Processor

3M Cache, 2.50 GHz

[Specifications](#)

[Compatible Products](#)

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## Essentials

|                            |                                           |
|----------------------------|-------------------------------------------|
| Product Collection         | 3rd Generation Intel® Core™ i3 Processors |
| Code Name                  | Products formerly Ivy Bridge              |
| Vertical Segment           | Mobile                                    |
| Processor Number           | i3-3120M                                  |
| Status                     | Launched                                  |
| Launch Date                | Q3'12                                     |
| Lithography                | 22 nm                                     |
| Recommended Customer Price | \$225.00                                  |

## Performance

|                          |                 |
|--------------------------|-----------------|
| # of Cores               | 2               |
| # of Threads             | 4               |
| Processor Base Frequency | 2.50 GHz        |
| Cache                    | 3 MB SmartCache |
| Bus Speed                | 5 GT/s DMI      |
| TDP                      | 35 W            |

## Supplemental Information

|                            |                          |
|----------------------------|--------------------------|
| Embedded Options Available | No                       |
| Conflict Free              | Yes                      |
| Datasheet                  | <a href="#">View now</a> |

[Learn how Intel is pursuing conflict-free technology.](#)

## Memory Specifications

|                                            |                      |
|--------------------------------------------|----------------------|
| Max Memory Size (dependent on memory type) | 32 GB                |
| Memory Types                               | DDR3/L/-RS 1333/1600 |

|                          |           |
|--------------------------|-----------|
| Max # of Memory Channels | 2         |
| Max Memory Bandwidth     | 25.6 GB/s |
| ECC Memory Supported †   | No        |

## Graphics Specifications

|                                                |                         |
|------------------------------------------------|-------------------------|
| Processor Graphics ‡                           | Intel® HD Graphics 4000 |
| Graphics Base Frequency                        | 650.00 MHz              |
| Graphics Max Dynamic Frequency                 | 1.10 GHz                |
| Graphics Output                                | eDP/DP/HDMI/SDVO/CRT    |
| Intel® Quick Sync Video                        | Yes                     |
| Intel® InTru™ 3D Technology                    | Yes                     |
| Intel® Flexible Display Interface (Intel® FDI) | Yes                     |
| Intel® Clear Video HD Technology               | Yes                     |
| # of Displays Supported ‡                      | 3                       |
| Device ID                                      | 0x166                   |

## Expansion Options

|                      |     |
|----------------------|-----|
| PCI Express Revision | 2.0 |
|----------------------|-----|

|                              |                    |
|------------------------------|--------------------|
| PCI Express Configurations ‡ | 1x16, 2x8, 1x8 2x4 |
|------------------------------|--------------------|

|                            |   |
|----------------------------|---|
| Max # of PCI Express Lanes | 1 |
|----------------------------|---|

## Package Specifications

|                   |          |
|-------------------|----------|
| Sockets Supported | FCPGA988 |
|-------------------|----------|

|                       |   |
|-----------------------|---|
| Max CPU Configuration | 1 |
|-----------------------|---|

|                       |                       |
|-----------------------|-----------------------|
| T <sub>JUNCTION</sub> | 90C (PGA); 105C (BGA) |
|-----------------------|-----------------------|

|              |                                                   |
|--------------|---------------------------------------------------|
| Package Size | 37.5mm x 37.5mm (rPGA988B); 31mm x 24mm (BGA1023) |
|--------------|---------------------------------------------------|

|                               |          |
|-------------------------------|----------|
| Low Halogen Options Available | See MDDS |
|-------------------------------|----------|

## Advanced Technologies

|                                 |    |
|---------------------------------|----|
| Intel® Turbo Boost Technology ‡ | No |
|---------------------------------|----|

|                          |    |
|--------------------------|----|
| Intel® vPro Technology ‡ | No |
|--------------------------|----|

|                                     |     |
|-------------------------------------|-----|
| Intel® Hyper-Threading Technology ‡ | Yes |
|-------------------------------------|-----|

|                                           |     |
|-------------------------------------------|-----|
| Intel® Virtualization Technology (VT-x) ‡ | Yes |
|-------------------------------------------|-----|

|                                                            |    |
|------------------------------------------------------------|----|
| Intel® Virtualization Technology for Directed I/O (VT-d) ‡ | No |
|------------------------------------------------------------|----|

|                                               |     |
|-----------------------------------------------|-----|
| Intel® VT-x with Extended Page Tables (EPT) ‡ | Yes |
|-----------------------------------------------|-----|

|                                         |        |
|-----------------------------------------|--------|
| Intel® 64 †                             | Yes    |
| Instruction Set                         | 64-bit |
| Instruction Set Extensions              | AVX    |
| Intel® My WiFi Technology               | Yes    |
| 4G WiMAX Wireless Technology            | Yes    |
| Idle States                             | Yes    |
| Enhanced Intel SpeedStep® Technology    | Yes    |
| Intel® Demand Based Switching           | No     |
| Thermal Monitoring Technologies         | Yes    |
| Intel® Fast Memory Access               | Yes    |
| Intel® Flex Memory Access               | Yes    |
| Intel® Identity Protection Technology † | Yes    |

## Intel® Data Protection Technology

|                             |    |
|-----------------------------|----|
| Intel® AES New Instructions | No |
|-----------------------------|----|

## Intel® Platform Protection Technology

|                                |    |
|--------------------------------|----|
| Trusted Execution Technology † | No |
|--------------------------------|----|

Execute Disable Bit ‡

Yes

Anti-Theft Technology

Yes

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Refer to Datasheet for formal definitions of product properties and features.

"Announced" SKUs are not yet available. Please refer to the Launch Date for market availability.

Some products can support AES New Instructions with a Processor Configuration update, in particular, i7-2630QM/i7-2635QM, i7-2670QM/i7-2675QM, i5-2430M/i5-2435M, i5-2410M/i5-2415M. Please contact OEM for the BIOS that includes the latest Processor configuration update.

‡ This feature may not be available on all computing systems. Please check with the system vendor to determine if your system delivers this feature, or reference the system specifications (motherboard, processor, chipset, power supply, HDD, graphics controller, memory, BIOS, drivers, virtual machine monitor-VMM, platform software, and/or operating system) for feature compatibility. Functionality, performance, and other benefits of this feature may vary depending on system configuration.

"Conflict free" and "conflict-free" means "DRC conflict free", which is defined by the U.S. Securities and Exchange Commission rules to mean products that do not contain conflict minerals (tin, tantalum, tungsten and/or gold) that directly or indirectly finance or benefit armed groups in the Democratic Republic of the Congo (DRC) or adjoining countries. Intel also uses the term "conflict-free" in a broader sense to refer to suppliers, supply chains, smelters and refiners whose sources of conflict minerals do not finance conflict in the DRC or adjoining countries. Intel processors manufactured before January 1, 2013 are not confirmed conflict free. The conflict free designation refers only to product manufactured after that date. For Intel Boxed Processors, the conflict free designation refers to the processor only, not to any additional included accessories, such as heatsinks/coolers.

See <http://www.intel.com/content/www/us/en/architecture-and-technology/hyper-threading/hyper-threading-technology.html?wapkw=hyper+threading> for more information including details on which processors support Intel® HT Technology.

Max Turbo Frequency refers to the maximum single-core processor frequency that can be achieved with Intel® Turbo Boost Technology. See [www.intel.com/technology/turboboost/](http://www.intel.com/technology/turboboost/) for more information.

The Recommended Customer Price ("RCP") is pricing guidance for Intel products. Prices are for direct Intel customers, typically represent 1,000-unit purchase quantities, and are subject to change without notice. Taxes and shipping, etc. not included. Prices may vary for other package types and shipment quantities, and special promotional arrangements may apply. If sold in bulk, price represents individual unit. Listing of these RCP does not constitute a formal pricing offer from Intel. Please work with your appropriate Intel representative to obtain a formal price quotation.

System and Maximum TDP is based on worst case scenarios. Actual TDP may be lower if not all I/Os for chipsets are used.

Low Halogen: Applies only to brominated and chlorinated flame retardants (BFRs/CFRs) and PVC in the final product. Intel components as well as purchased components on the finished assembly meet JS-709 requirements, and the PCB / substrate meet IEC 61249-2-21 requirements. The replacement of halogenated flame retardants and/or PVC may not be better for the environment.

For benchmarking data see <http://www.intel.com/performance>.

Intel processor numbers are not a measure of performance. Processor numbers differentiate features within each processor family, not across different processor families. See <http://www.intel.com/content/www/us/en/processors/processor-numbers.html> for details.

Processors that support 64-bit computing on Intel® architecture require an Intel 64 architecture-enabled BIOS.